

2023 Joint Asia-Pacific Symposium on Electromagnetic Compatibility (APEMC) and International Conference on Electromagnetic Interference & Compatibility (INCEMIC)



22 - 25 May, 2023

Sheraton Grand, Bengaluru, India

ANNOUNCEMENT AND CALL FOR PAPERS

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The Joint APEMC and INCEMIC 2023, will be held as an on-site conference from 22nd to 25th May 2023 in Bengaluru, the Garden City of India. The Venue will be Sheraton Grand Bengaluru. This will mark the 14th edition of APEMC and the 16th edition of INCEMIC. The event will be jointly organized by the IEEE EMC Chapter, Bengaluru, and the Society of EMC Engineers, India (SEMCEI). The symposium will continue the APEMC spirit to engage and address the worldwide EMC community with a primary focus on the Asia-Pacific region. The symposium will recognize innovations and technology leadership through Best Symposium Paper, Best Poster Award, and Best Student Paper Award. The scope of symposium will encompass the entire spectrum of electromagnetic compatibility, electromagnetic environment, and signal and power integrity.

The symposium Technical Program Committee invites you to submit your original and unpublished papers in all aspects of electromagnetic compatibility (EMC) as well as signal and power integrity (SI/PI), including but not limited to EMC/SI/PI design, modelling, management, measurements, and education. Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements. Plan ahead and join this unique symposium, meet international colleagues, present your latest research findings, share your insight and perspectives, ask questions, learn from experts, and innovators, explore collaborations, visit exhibitions and see new products.

Important Dates

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| Regular paper submission deadline | 15 Jan, 2023 |
| Acceptance notification to authors | 15 Feb, 2023 |
| Deadline for exhibitor | 15 Apr, 2023 |

Paper Topics of Interest

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| EMC Management and Standards | EMC in Space and Aeronautics | EMC Measurements and Environment |
| IC and Semiconductor EMC | Lightning | Signal Integrity and Power Integrity |
| High Power Electromagnetics | Wireless Communication EMC | Renewable Energy and Smart Power Grid EMC |
| Computational Electromagnetics and Multiphysics | System level EMC and Protection | Bio-Medical EMC |
| Automotive and Railway EMC | Nanotechnology and Materials | EMC in Military |

Theme of the symposium: EMC in eMobility

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